Search MBOI Masters

Manufacturing Info MBOI Specifications

PH4 ISPL (ATEC) (CU) MBOI Data

Search Files: 74LCX244MTCX-IPN

Supply
Purchasing/Payables Planning APSFR

Factory Information
Capacity Statement
Quality
Global EBR5 External Manufacturing MPE

Data Exchange Document and Data Exchange Intransit Exceptions

Search text is highlighted in RED 74LCX244MTCX-IPN

ASY (850) MEF (4) TST (925) Open Compliance (832)

Manufacturing Bill of Information (MBOI)						
Part Number	74LCX244MTCX-IPN-ASY	Part Type	Assembly Part			
Site Name Loc Cod	PH4 ISPL (ATEC) CU	File Name	PH4_74LCX244MTCX-IPN_74LCX244MTCX-IPN-ASY_ASY			
Flags	Non Safe Launch Item No Global Hold Flag	Part Qual Target Market:	I Industrial			
Part Version	4	Part Version Date-Time	2024-MAY-05 05:42:39 (GMT +7)			

	l .						
	Orderable Part Section - OPN						
Part Number Desc	74LCX244MTCX-IPN LV Buffer/Line Driver	Market PN	74LCX244MTCX-IPN				
Lifecycle Phase	Production	Part Class Desc	AA ASSEMBLED AND TESTED				
Marketing Product Lifecycle	Follow Part Lifecycle	Part Sub Type	OPN				
Part Release Status Desc	MC-M Mass Production	Part Usage	STD				
Case Outline (CO)	948AQ DP	PAL4 Code Desc	I				
Product Data Sheet							
ERP Resource Code - ASY Desc	F303 TSSOP20 AU SNGL HPBF	OPN Part Qual Target Market	I Industrial				
Packing Configuration	TSSOP-20_948AQ_REEL_2500	Eng Package Type	TSSOP-20				

Assembly_Part_Section - ASY					
Part Number	74LCX244MTCX-IPN-ASY	Description	LV Buffer/Line Driver		
Lifecycle Phase	Production	Part Usage	STD		
Part Release Status Desc	MC-M Mass Production	Part Sub Type	ASY		
PAL4 Code Desc	I	ERP Resource Code - ASY Desc	F303 TSSOP20 AU SNGL HPBF		
Part Qual Target Market	I Industrial				
Case Outline (CO)	948AQ DP	Package Type	TSSOP-20		
ECAT Override		Actual Lead Count	20		
Package Assembly Platform	SOSM - Small Outline Surface Mount	Assembly Baseline Spec			
Assembly Process Flow Spec		Assembly Spec(s) - Global			
Lot Processing Restrictions	Standard	Package Substrate Layout(s)			
ITAR Part Flag	N	Customs Configuration	8542.39.0001		
Customs ECCN Code	EAR99	Customer Consigned Flag	N		
Compressed?		Compressed Part Number			
Wettable Process Type		Wettable Flank Flag			
Site Notes					

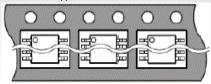
BOM Components										
Alternate 001	Part Number	Part Sub Type	Line	Preference	Group	Qty	Description	Lifecycle Phase		
Primary Die	LCX244-WBC3026D-WDQ	WDQ	001	01	0	1	Wafer 200	Production		
	Die Size (X + Y W/Scribe Stre	Die Size (X + Y W/Scribe Street): 880 x 950 PDPW : 33658								
Package Kit	N17608G034 PKT 002 01 0 1 PKGKIT TSSOP20 CU (PH4) Pr						Production			
	Piece Parts	Piece Parts								
	1360100017	1360100017 FRAME 010 01 0 1					LF TSSOP 20L JEDEC 4.4MM STAMPED PPF	Production		
	13601510001	EPXY	020	01	0	1	DA EPOXY HE QMI519 10CC CON	Production		
	1360162000	WIRE	030	01	0	1	BW Au 0.9 MIL	Production		
	1360191001 MOLD 040 01 0 1 MC HITACHI CEL800JF 13MM X 4.1G							Production		
BOI 67-Bonding Diagram	67AON20273G A	DOC	003	01	0	1	74LCX244x Series	Production		

Standard Marking Flag		
PB Free Mark Character Flag		
Consolidated Mark Machine Std	Consolidated Mark Machine Custom	Line1: \$Y&Z&2&K Line2: LCX244 Line3: UNK Line4: UNK Line5: UNK

	Marking Details Sectio	n
Date Code Type	S2	
Trace Code Legend - Front		
Trace Code Legend - Back		
Trace Code Spec	12MON45426G BD	Part Marking Source
Part Marking Image/CAD Document		Marking Style Image Document
Custom Logo Document		ON Logo Document
Final Test Specification	48AON61241H O	

OPN Packing Section						
PCQ Container Desc	REEL Tape and Reel	PCQ Quantity	2500			
MPQ Container Desc	REEL Tape and Reel	MPQ Quantity	2500			
Intermediate Full Box Container Type Intermediate Box Container Size Intermediate Full Box Container Quantity	 5000	Intermediate Full Bag Container Type Intermediate Bag Container Size Intermediate Full Bag Container Quantity				

Pin 1 Toward Upper Left



Labeling Section							
MSL	1	MSL Temperature	260				
Pb Free Leads Flag	Υ	Halide Free Flag	N				
Pb Free Die Attach Flag	Υ	Lead Finish Category (eCAT)	e4				

Document Group Section				
Document Num	Revision	Release Date	Title	
12MON01117D	AC	15-Nov-23	Quality Assurance Inspection and Testing Sample Plan	
12MON03769D	Υ	04-Jul-22	External Visual Inspection Criteria	
12MON45426G	BD	02-Feb-23	Mark Layout Instructions	
12MON49004E	AD	14-Apr-23	Subcontractors Bar Code Labeling	
12MRB17500B	FM	19-Sep-23	Finished Goods Packing and Long Term Storage Procedure	
12MRM92695A	AE	27-Feb-24	Lot Combination Control Requirements for onsemi	
48AON61241H	0	05-Feb-24	74VHCxx, 74LCXxx & 74LVXxx Series	
67AON20273G	A	02-Feb-24	74LCX244x Series	

			BOM Links
Up/Down Direction	Site	Top Part	Link
Up	PH4	74LCX244MTCX-IPN	PH4_74LCX244MTCX-IPN_74LCX244MTCX-IPN-TST_TST.XML

	Revision History					
Rev	Rev Date	Details				
4	2024-FEB-21 05:03:44	LIFECYCLE_PHASE CONFIRM_REQUIRED previous_value:Prototype;new_value:Production LIFECYCLE_PHASE CONFIRM_REQUIRED previous_value:Prototype;new_value:Production PART_REL_DATE_PROD UPDATE_FILE_AND_VERSION previous_value:NULL;new_value:20-FEB-24				
3	2024-FEB-05 15:09:51	CONTROLLING_DOC UPDATE_FILE_AND_VERSION previous_value:48AON88777F;new_value:48AON61241H				

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		MARK_STYLE_SPEC UPDATE_FILE_AND_V PB_FREE_DIE_ATTACH_FLG_CONFIRM_RE	· –		
2	2024-JAN-23 15:04:50	PB_FREE_IND_G_CD_IND UPDATE_FILE_A	AND_VERSION previous_val	value:NULL;new_value:None	
		PB_FREE_LEADS_FLG CONFIRM_REQUIR PIN1_IND UPDATE_FILE_AND_VERSION pr		_	
		POLARITY_IND UPDATE_FILE_AND_VERSI		-	
1	2024-JAN-18 00:03:50	Initial version	Sion previous_value.1,fiew_	w_value.iv	

About onsemi	Investor Relations	News & Media
Locations	Governance	Press Announcements
Leadership	Financials	In The News
Corporate Fact Sheet	Events	Blog
Quality and Reliability	News	Media Contacts
Ecosystem Partners	Stock Info	
Intellectual Property	FAQ	
Our History		
Careers		
Experienced Careers		
Early Careers		
Search & Apply		
Internships		
Who We Are		
Career Benefits		
Where We Are		



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